

ELECTRONICALLY FILED ON 03 OCTOBER 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Marcos Karnezos	Attorney Docket No.: CPAC 1017-5 D3
Application No.: 10/632,552	Examiner: Chris C. Chu
Filed: 02 August 2003	Group: 2815
Title: Semiconductor Multi-Package Module Having Package Stacked Over Die-Up Flip Chip Ball Grid Array Package And Having Wire Bond Interconnect Between Stacked Packages	Confirmation No.: 2572
	Customer No. 22470

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

It is requested that the information identified in this statement be considered by the Examiner and made of record in the above-identified application. This statement is not intended to represent that a search has been made or that the information cited in the statement is, or is considered to be, material to patentability as defined in 37 C.F.R. 1.56.

Enclosed with this statement is a Form PTO/SB/08A. The Examiner is requested to initial the form and return it to the undersigned in accordance with M.P.E.P. 609.

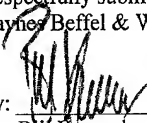
Also enclosed with this statement is a copy of each cited document as required by 37 C.F.R. 1.98. However, since this application was filed after June 30, 2003, copies of U. S. Patents and U. S. Patent Application Publications are not enclosed. (See O. G. Notice of August 5, 2003.)

This statement should be considered under 37 C.F.R. 1.97(c) because it is being filed before the mailing date of a FINAL office action, a Notice of Allowance, or an action that otherwise closes prosecution in the subject application, whichever occurs first, AND it is accompanied by the \$180 fee set forth in 37 C.F.R. 1.17(p).

Fee Authorization. The Commissioner is hereby authorized to charge any additional fees or credit any overpayment associated with this communication to Deposit Account No. 50-0869 (CPAC 1017-5 D3).

Respectfully submitted,
Haynes Beffel & Wolfeld LLP

Date: 03 October 2006

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Sheet 1 of 1

Application Number	10/632,552		
Filing Date	02 August 2003		
First Named Inventor	Marcos Karnezos		
Art Unit	2815		
Examiner Name	Chris C. Chu		
Attorney Docket Number	CPAC 1017-5		

U.S. PATENT DOCUMENTS

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Examiner Signature		Date Considered	
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